



# ENG-E22-047 - Distributors

JAE Electronics, Inc.  
May 31<sup>st</sup>, 2022

## PCN (Process Change Notice) MX34040SF1 Replacement Mold Die (L,M) To Keep Production Capacity

Part Number	2 Existing Mold Dies – Each die has 2 cavities	Create 1 Replacement Mold Die with 2 cavities	Replacement Mold Die Completion	Proposed PPAP Submission	Start of Mass Production (SOP)
MX34040SF1	(E,F), (G,H)  Pending PCN, (ENG-E22-009) for mold die (J,K) to replace (E,F) once (E,F) is reached to EOL	(L,M) to replace (G,H)	October 2022	November 2022	January 2023

Notes:

- PC = Process Change (Tooling: Transfer, Replacement, Refurbishment, or additional and Parts Produced at Additional Location, etc...)
- PPAP = Production Part Approval Process
  1. PC PPAP will only be prepared and provided to customer who already received and provided initial PPAP approval.
  2. If you request PPAP documents for this notification, please notify us ASAP.

Thank you vey much.